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2013年11月

FAN7371

大电流高侧栅极驱动 IC

特性

- 浮动通道可实现高达 +600V 的自举运行
- 4 A/4 A 源电流 / 灌电流驱动能力
- 共模 dv/dt 噪声消除电路
- 兼容 3.3V 和 5V 逻辑输入电平
- 输出信号与输入信号同相位
- V_{BS} 欠压锁定
- V_{DD} 和 V_{BS} 上有 25 V 的 电压调节器
- 8- 引脚小尺寸封装 (SOP)

应用

- 高速栅极驱动器
- PDP 应用中的维持放电开关驱动器
- PDP 应用中的能量恢复电路开关驱动器
- 高功率降压转换器
- 电机驱动变频器

说明

FAN7371 是单片高侧栅极驱动器 IC,可以驱动工作电压 最高达 +600V 的高速 MOSFET 和 IGBT。它具有缓冲输 出级,且所有 NMOS 晶体管设计为具有高脉冲电流驱动 能力和最低交叠导通。

飞兆的高压流程和共模噪声消除技术可使高端驱动器在高 dv/dt 噪声环境下稳定运行。先进的电平转换电路允许高 侧栅极驱动器的偏置电压达到 V_{S} = -9.8 V (V_{BS} = 15 V 时的典型值)。

UVLO 电路可防止 V_{BS} 低于指定的阈值电压时发生故障。

大电流和低输出压降功能使得此器件适合作为等离子显示 面板应用中的维持开关驱动器和能量恢复电路驱动器、电 机驱动变频器、开关电源和大功率 DC-DC 转换器应用。

8-SOP



订购信息

器件编号	封装	工作 温度范围	⊘ Eco 标志	包装方法	
FAN7371M ⁽¹⁾	8-SOP	-40°C ~ 125°C	RoHS	塑料管	
FAN7371MX ⁽¹⁾	0-30F	-40 C ~ 125 C	Kuris	卷带和卷盘	

注:

1. 这些器件通过了 JESD22A-111 波峰焊测试。



对于飞兆公司的生态标志定义,请访问: http://www.fairchildsemi.com/company/green/rohs green.html。

应用电路图

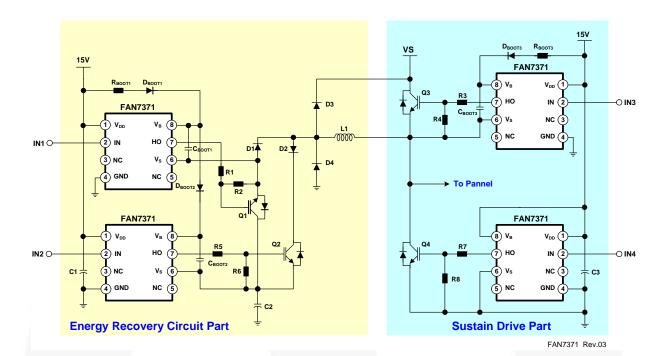


图 1. 浮动双向开关和半桥驱动器: PDP 应用

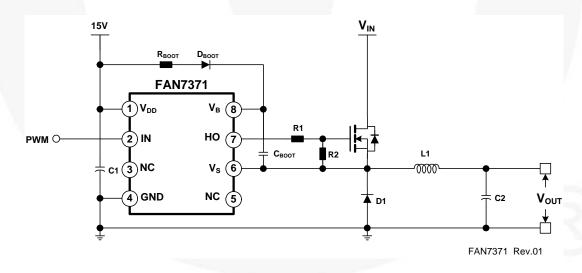
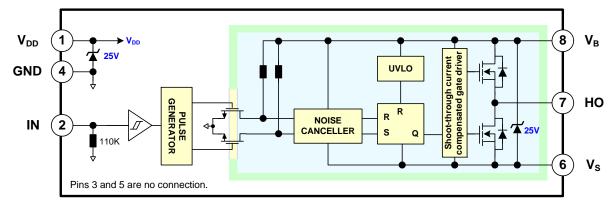


图 2. 降压直流 - 直流转换器应用

内部框图



FAN7371 Rev.04

图 3. 功能框图

引脚配置

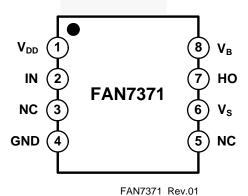


图 4. 引脚配置 (俯视图)

引脚定义

引脚号	名称	说明
1	V_{DD}	电源电压
2	IN	高侧栅极驱动器输出的逻辑输入
3	NC	无连接
4	GND	接地
5	NC	无连接
6	V _S	高侧浮动电源电压返回
7	НО	高侧驱动输出
8	V _B	高侧浮动电源

绝对最大额定值

应力超过绝对最大额定值,可能会损坏器件。在超出推荐的工作条件的情况下,该器件可能无法正常工作,所以不建议让器件在这些条件下长期工作。此外,长期在高于推荐的工作条件下工作,会影响器件的可靠性。绝对最大额定值仅是应力规格值。除非另有说明, $T_A=25^{\circ}C$ 。

符号	特性	最小值	最大值	单位
V _S	高侧浮动偏置电压	V _B -V _{SHUNT}	V _B +0.3	V
V _B	高侧浮动电源电压 ⁽²⁾	-0.3	625.0	V
V _{HO}	高侧浮动输出电压	V _S -0.3	V _B +0.3	V
V_{DD}	低侧和逻辑电源电压 (2)	-0.3	V _{SHUNT}	V
V _{IN}	逻辑输入电压	-0.3	V _{DD} +0.3	V
dV _S /dt	允许的偏置电压变化速率		± 50	V/ns
P _D	功耗 ^(3, 4, 5)		0.625	W
θ_{JA}	热阻		200	°C/W
TJ	结温	-55	+150	°C
T _{STG}	存储温度	-55	+150	°C
T _A	操作环境温度	-40	+125	°C

注意:

- 2 该 IC 在 V_{DD} 和 V_{BS} 上包含一个电压调节器,标准击穿电压为 25 V_{\odot} 请注意该电源引脚不能由比电气特性部分指定的 V_{SHUNT} 高的低阻抗电压源驱动。
- 3 安装到 76.2 x 114.3 x 1.6mm PCB 板 (FR-4 环氧玻璃材料)。
- 4 参照下列标准:
 - JESD51-2: 集成电路热测试方法环境条件 自然对流;
 - JESD51-3: 含铅表面贴装封装的低有效导热系数测试板。
- 5 任何情况下,都不得超过功耗 (P_D)。

推荐工作条件

推荐的操作条件表明确了器件的真实工作条件。指定推荐的工作条件,以确保器件的最佳性能达到数据表中的规格。 飞兆不建议超出额定或依照绝对最大额定值进行设计。

符号	参数	最小值	最大值	单位
V _{BS}	高侧浮动电源电压	V _S +10	V _S +20	V
V _S	高侧浮动电源偏置电压	6-V _{DD}	600	V
V _{HO}	高侧输出电压	Vs	V _B	V
V _{IN}	逻辑输入电压	GND	V _{DD}	V
V _{DD}	电源电压	10	20	V

电气特性

除非另有说明, $V_{BIAS}(V_{DD}$ 、 $V_{BS})$ =15.0V、 T_A = 25°C。 V_{IN} 和 I_{IN} 参数以 GND 作为基准。 V_O 和 I_O 参数以 V_S 为参考点,适用于对应的输出 HO。

符号	特性	测试条件	最小值	典型值	最大值	单位
电源部分		1		ı		
I_{QDD}	V _{DD} 静态电源电流	V _{IN} = 0 V 或 5 V		25	70	μА
I _{PDD}	V _{DD} 工作电源电流	f _{IN} = 20 KHz,空载		35	100	μΑ
自举电源	部分		· ·	•	•	
V _{BSUV+}	V _{BS} 电源欠压正向阈值	V _{BS} = 扫描	8.2	9.2	10.2	V
V _{BSUV} -	V _{BS} 电源欠压负向阈值	V _{BS} = 扫描	7.5	8.5	9.5	V
V_{BSHYS}	V _{BS} 电源欠压锁定滞回电压回差	V _{BS} = 扫描		0.7		V
I _{LK}	偏置漏电流	$V_B = V_S = 600V$			10	μΑ
I_{QBS}	V _{BS} 静态电源电流	V _{IN} = 0 V 或 5 V	4	60	120	μΑ
I _{PBS}	V _{BS} 工作电源电流	C _{LOAD} = 1 nF, f _{IN} = 20 KHz, rms 值		1.0	2.8	mA
电压调节	器部分			l		
V _{SHUNT}	V _{DD} 和 V _{BS} 电压调节器钳位电压	I _{SHUNT} =5mA	24	25		V
输入逻辑	部分			•		
V_{IH}	逻辑 "1" 输入电压		2.5			V
V_{IL}	逻辑 "0" 输入电压				0.8	V
I _{IN+}	逻辑输入高电平偏置电流	V _{IN} =5V		45	70	μΑ
I _{IN-}	逻辑输入低电平偏置电流	V _{IN} =0V			2	μΑ
R _{IN}	输入下拉电阻		70	110		ΚΩ
栅极驱动	器输出部分					
V_{OH}	高电平输出电压 (V _{BIAS} - V _O)	无负载			1.2	V
V _{OL}	低电平输出电压	无负载			30	mV
I _{O+}	输出高电平短路脉冲电流 (6)	V _{HO} =0V, V _{IN} =5V, PW ≤10μs	3.0	4.0		Α
I _{O-}	输出低电平短路脉冲电流 ⁽⁶⁾	V _{HO} =15V,V _{IN} =0V, PW ≤10μs	3.0	4.0		Α
V _S	IN 信号传播到 HO 时允许的 V _S 引脚负电压		1	-9.8	-7.0	V

注:

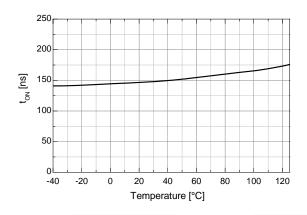
6 这些参数由设计保证。

动态电气特性

除非另有说明, $V_{DD} = V_{BS} = 15V$ 、 GND = 0V、 $C_{LOAD} = 1000 pF$ 、 $T_A = 25 ^{\circ}C$ 。

符号	参数	工作条件	最小值	典型值	最大值	单位
t _{on}	导通传播延时时间	V _S =0V		150	210	ns
t _{off}	关断传播延时时间	V _S =0V		150	210	ns
t _r	导通上升时间			25	50	ns
t _f	关断下降时间			15	40	ns

典型特性



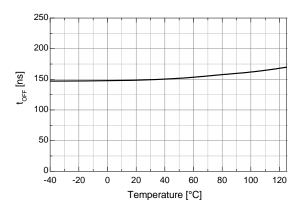
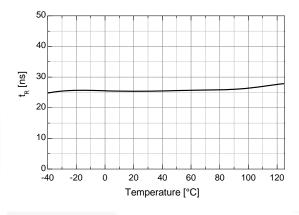


图 5. 导通传播延时与温度的关系

图 6. 关断传播延时与温度的关系



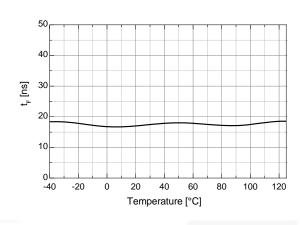
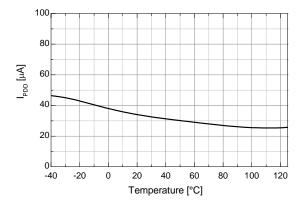


图 7. 导通上升时间与温度的关系

图 8. 关断下降时间与温度的关系



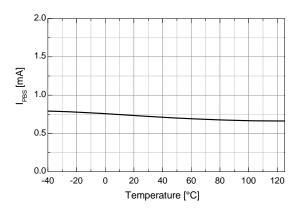
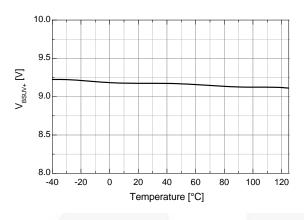


图 9. 工作时 V_{DD} 电源电流与温度的关系

图 10. V_{BS} 工作电源电流与温度的关系

典型特性 (续)



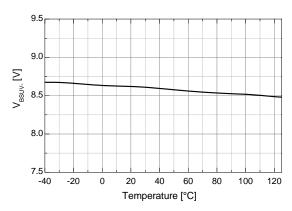
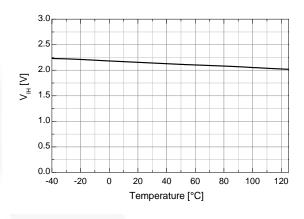


图 11. V_{BS} UVLO+ 与温度的关系

图 12. V_{BS} UVLO- 与温度的关系



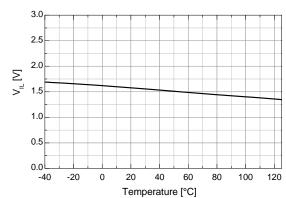
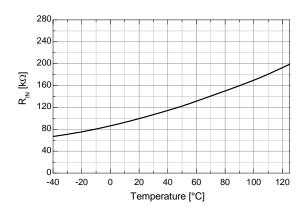


图 13. 逻辑高电平输入电压与温度的关系

图 14. 逻辑低电平输入电压与温度的关系



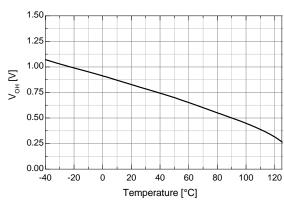
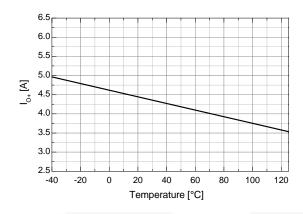


图 15. 输入下拉电阻与温度的关系

图 16. 高电平输出电压与温度的关系

典型特性 (续)



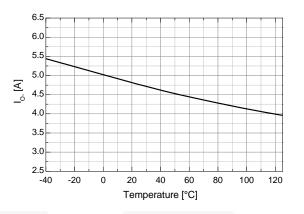
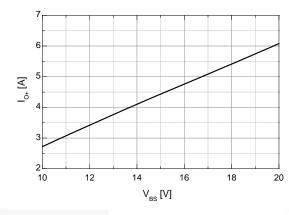
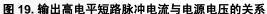


图 17. 输出高电平短路脉冲电流与温度的关系

图 18. 输出低电平短路脉冲电流与温度的关系





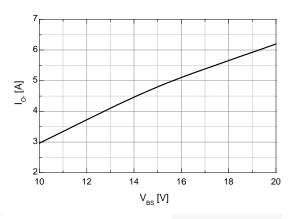


图 20. 输出低电平短路脉冲电流与电源电压的关系

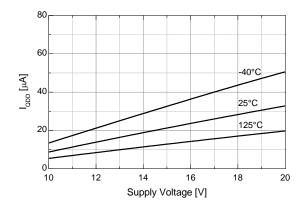


图 21. V_{DD} 静态电源电流与电源电压的关系

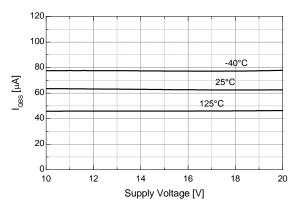


图 22. V_{BS} 静态电源电流与电源电压的关系

开关时间定义

时序图

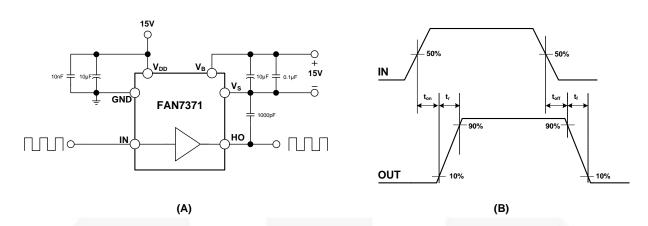
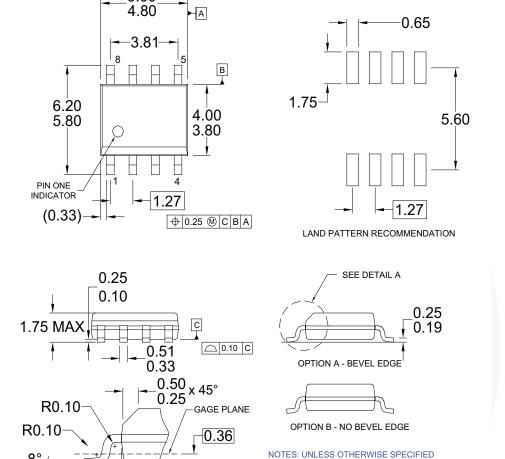


图 23. 开关时间测试电路和波形定义

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图 24. 8- 引脚小尺寸封装 (SOP)

SEATING PLANE

-(1.04)

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